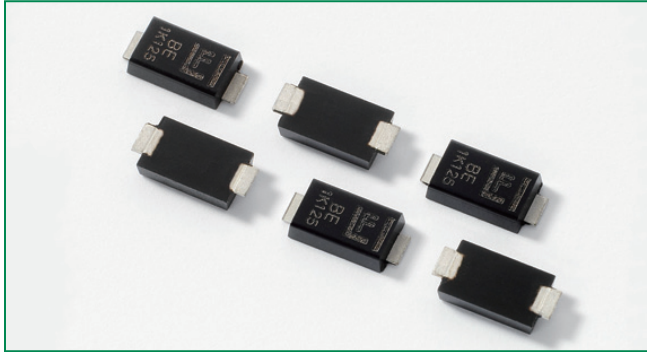


SMA6L Series

HF **RoHS**


Maximum Ratings and Thermal Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at $T_A=25^\circ\text{C}$ by 10x1000 μs waveform (Fig.2)(Note 1), (Note 2)	P_{PPM}	600	W
Power Dissipation on infinite heat sink at $T_A=50^\circ\text{C}$	P_{MAV}	3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I_{FSM}	60	A
Maximum Instantaneous Forward Voltage at 25A for Unidirectional only	V_F	3.5V	V
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-65 to 150	$^\circ\text{C}$
Typical Thermal Resistance Junction to Lead	R_{JL}	35	$^\circ\text{C}/\text{W}$
Typical Thermal Resistance Junction to Ambient	R_{JA}	200	$^\circ\text{C}/\text{W}$

Notes:

1. Non-repetitive current pulse, per Fig.4 and derated above $T_A=25^\circ\text{C}$ per Fig. 3.
2. Mounted on 5.0x5.0mm copper pad to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only.

Description

The SMA6L series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

SMA low profile package has the same electrical performance as the SMB package but with lowest height profiles (1.1mm) in the industry.

Features

- SMA low profile package: less than 1.1 mm
- Same power as standard SMB devices (600 W)
- Footprint compatibility with standard SMA and SMB products (easy to layout)
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Low inductance, excellent clamping capability
- Fast response time: typically less than 1.0ns from 0 Volts to V_{BR} min
- Built-in strain relief
- Glass passivated junction
- Typical I_R less than 1 μA above 12V
- High temperature soldering: 260 $^\circ\text{C}/40$ seconds at terminals
- Typical maximum temperature coefficient $\Delta V_{BR} = 0.1\% \times V_{BR}@25^\circ\text{C} \times \Delta T$
- Matte tin lead-free plated
- Halogen free and RoHS compliant

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

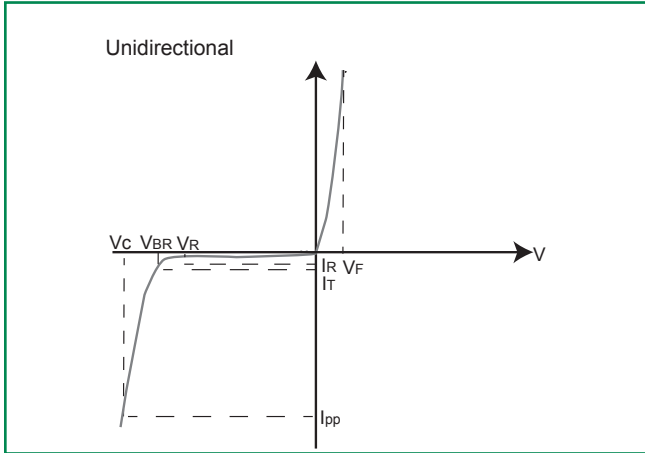
Electrical Characteristics

Part Number (Uni)	Marking	Reverse Stand off Voltage V_R (Volts)	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T (mA)	Maximum Clamping Voltage V_C @ I_{PP} (V)	Maximum Peak Pulse Current I_{PP} (A)	Maximum Reverse Leakage I_R @ V_R (μ A)
	UNI		MIN	MAX				
SMA6L5.0A	AE	5.0	6.40	7.00	10	9.2	65.3	800
SMA6L6.0A	AG	6.0	6.67	7.37	10	10.3	58.3	800
SMA6L6.5A	AK	6.5	7.22	7.98	10	11.2	53.6	500
SMA6L7.0A	AM	7.0	7.78	8.60	10	12.0	50.0	200
SMA6L7.5A	AP	7.5	8.33	9.21	1	12.9	46.6	100
SMA6L8.0A	AR	8.0	8.89	9.83	1	13.6	44.2	50
SMA6L8.5A	AT	8.5	9.44	10.40	1	14.4	41.7	20
SMA6L9.0A	AV	9.0	10.00	11.10	1	15.4	39.0	10
SMA6L10A	AX	10.0	11.10	12.30	1	17.0	35.3	5
SMA6L11A	AZ	11.0	12.20	13.50	1	18.2	33.0	1
SMA6L12A	BE	12.0	13.30	14.70	1	19.9	30.2	1
SMA6L13A	BG	13.0	14.40	15.90	1	21.5	28.0	1
SMA6L14A	BK	14.0	15.60	17.20	1	23.2	25.9	1
SMA6L15A	BM	15.0	16.70	18.50	1	24.4	24.6	1
SMA6L16A	BP	16.0	17.80	19.70	1	26.0	23.1	1
SMA6L17A	BR	17.0	18.90	20.90	1	27.6	21.8	1
SMA6L18A	BT	18.0	20.00	22.10	1	29.2	20.6	1
SMA6L20A	BV	20.0	22.20	24.50	1	32.4	18.6	1
SMA6L22A	BX	22.0	24.40	26.90	1	35.5	16.9	1
SMA6L24A	BZ	24.0	26.70	29.50	1	38.9	15.5	1
SMA6L26A	CE	26.0	28.90	31.90	1	42.1	14.3	1
SMA6L28A*	CG	28.0	31.10	34.40	1	45.4	13.3	1
SMA6L30A*	CK	30.0	33.30	36.80	1	48.4	12.4	1
SMA6L33A*	CM	33.0	36.70	40.60	1	53.3	11.3	1
SMA6L36A*	CP	36.0	40.00	44.20	1	58.1	10.4	1
SMA6L40A*	CR	40.0	44.40	49.10	1	64.5	9.3	1
SMA6L43A*	CT	43.0	47.80	52.80	1	69.4	8.7	1
SMA6L45A*	CV	45.0	50.00	55.30	1	72.7	8.3	1
SMA6L48A*	CX	48.0	53.30	58.90	1	77.4	7.8	1
SMA6L51A*	CZ	51.0	56.70	62.70	1	82.4	7.3	1
SMA6L54A*	RE	54.0	60.00	66.30	1	87.1	6.9	1
SMA6L58A*	RG	58.0	64.40	71.20	1	93.6	6.5	1
SMA6L60A*	RK	60.0	66.70	73.70	1	96.8	6.2	1
SMA6L64A*	RM	64.0	71.10	78.60	1	103.0	5.9	1
SMA6L70A*	RP	70.0	77.80	86.00	1	113.0	5.3	1
SMA6L75A*	RR	75.0	83.30	92.10	1	121.0	5.0	1
SMA6L78A*	RT	78.0	86.70	95.80	1	126.0	4.8	1
SMA6L85A*	RV	85.0	94.40	104.00	1	137.0	4.4	1

Notes:

Parts with "*" are still under development.

I-V Curve Characteristics



- P_{ppm} Peak Pulse Power Dissipation** – Max power dissipation
- V_r Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V_{br} Breakdown Voltage** – Maximum current that flows through the TVS at a specified test current (I_t)
- V_c Clamping Voltage** – Peak voltage measured across the suppressor at a specified I_{ppm} (peak impulse current)
- I_r Reverse Leakage Current** – Current measured at V_r
- V_f Forward Voltage Drop for Uni-directional**

Ratings and Characteristic Curves (T_A = 25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

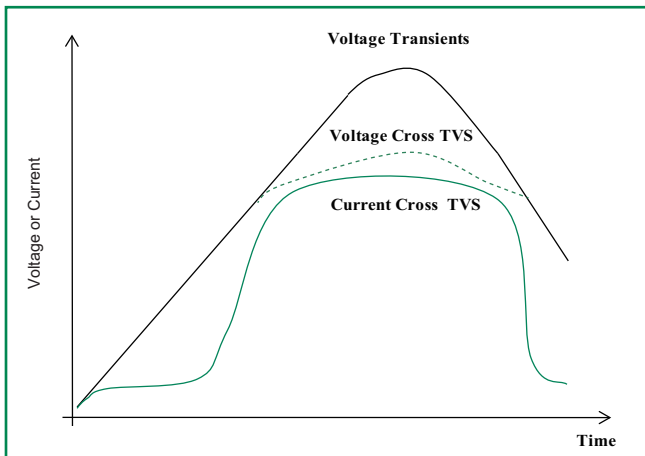
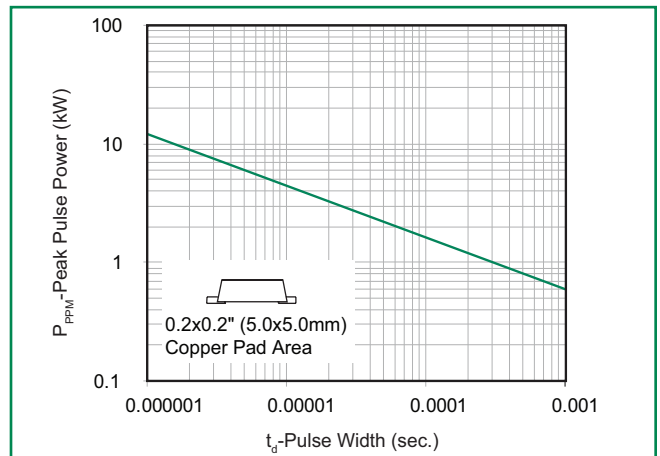


Figure 2 - Peak Pulse Power Rating Curve



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Figure 3 - Pulse Derating Curve

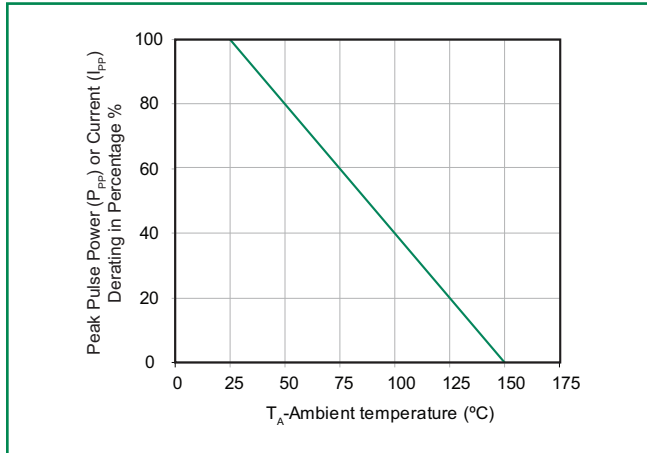


Figure 4 - Pulse Waveform

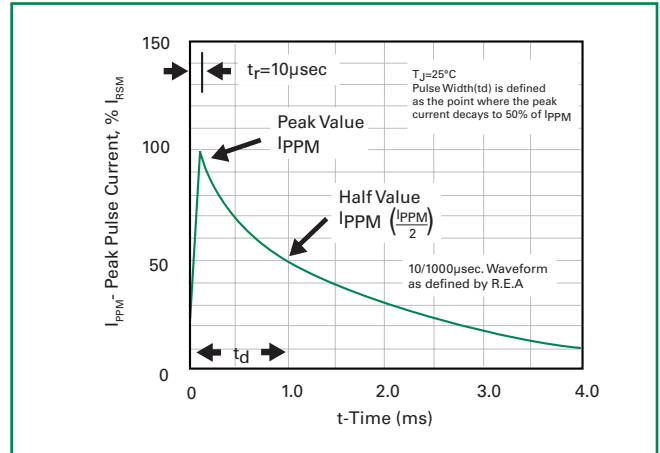


Figure 5 - Typical Junction Capacitance

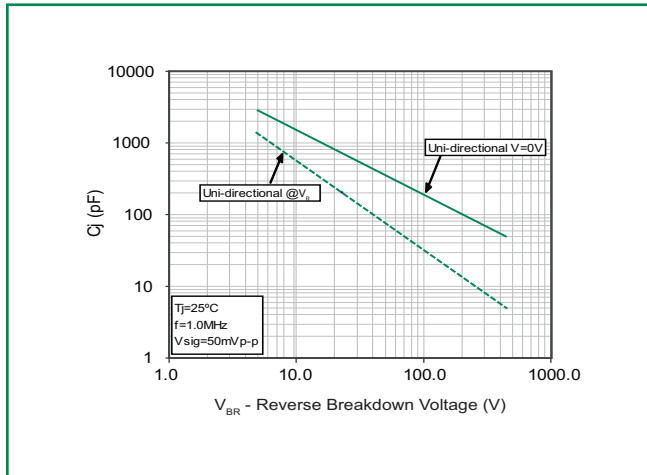
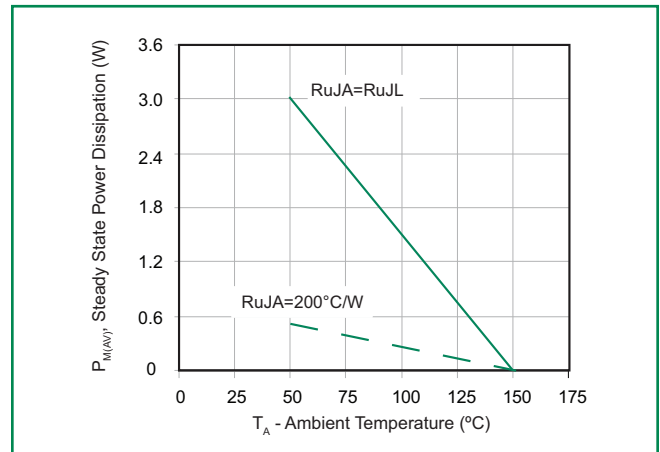
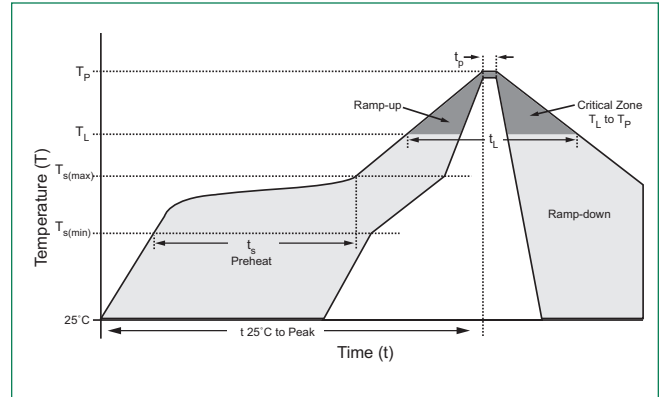


Figure 6 - Steady State Power Dissipation Derating Curve



Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		280°C



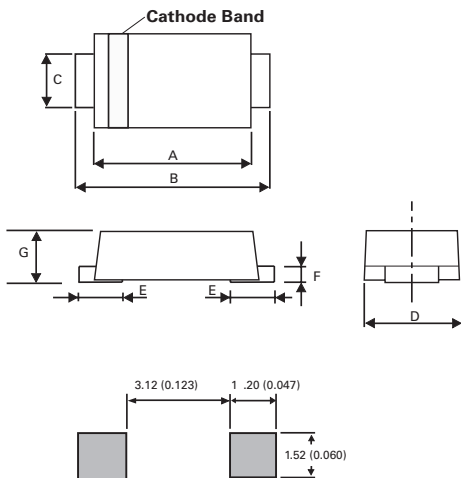
Physical Specifications

Weight	0.002 ounce, 0.061 gram
Case	JEDEC DO-221AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except Bipolar
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102D

Environmental Specifications

Temperature Cycle	JESD22-A104
Pressure Cooker	JESD22-A102
High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Thermal Shock	JESD22-A106

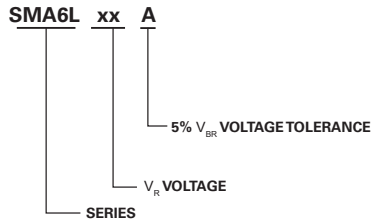
Dimensions



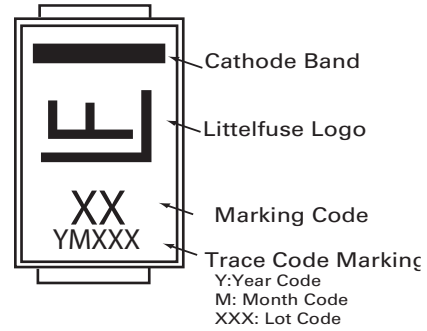
Mounting Pad Layout

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.156	0.181	3.950	4.600
B	0.189	0.220	4.800	5.600
C	0.049	0.069	1.250	1.750
D	0.088	0.116	2.250	2.950
E	0.030	0.059	0.750	1.500
F	0.005	0.010	0.125	0.250
G	0.035	0.043	0.900	1.100

Part Numbering System



Part Marking System



Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMA6LxxA	DO-221AC	3000	Tape & Reel – 12mm/7" tape	EIA RS-481

Tape and Reel Specification

